

2A, 50V - 1000V Fast Recovery Surface Mount Rectifier

FEATURES

- AEC-Q101 qualified
- Low power loss, high efficiency
- Ideal for automated placement
- Glass passivated chip junction
- Fast switching for high efficiency
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free

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- DC to DC converter
- Automotive application
- Car lighting
- Snubber
- Freewheeling application

MECHANICAL DATA

- Case: DO-214AA (SMB)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- · Polarity: Indicated by cathode band
- Weight: 0.090g (approximately)

KEY PARAMETERS							
PARAMETER	VALUE	UNIT					
lf	2	Α					
V _{RRM}	50 - 1000	V					
I _{FSM}	50	Α					
T _J MAX	175	°C					
Package	DO-214AA (SMB)						
Configuration	Single	die					









DO-214AA (SMB)



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)									1
PARAMETER	SYMBOL	RS	RS	RS	RS	RS	RS	RS	UNIT
T ANAMETER	STWIDGE	2AH	2BH	2DH	2GH	2JH	2KH	2MH	
Marking code on the device		RS2A	RS2B	RS2D	RS2G	RS2J	RS2K	RS2M	
Repetitive peak reverse voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Reverse voltage, total rms value	V _{R(RMS)}	35	70	140	280	420	560	700	V
Forward current	l _F	2						Α	
Surge peak forward current, 8.3ms single half sine-wave superimposed on rated load	Ігѕм	50					А		
Junction temperature	TJ	- 55 to +175					°C		
Storage temperature	T _{STG}	- 55 to +175						°C	

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THERMAL PERFORMANCE							
PARAMETER	SYMBOL	TYP	UNIT				
Junction-to-ambient thermal resistance	Reja	55	°C/W				
Junction-to-lead thermal resistance	Rejl	18	°C/W				

ELECTRICAL SPECIFICATIONS (TA = 25°C unless otherwise noted)								
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT			
Forward voltage ⁽¹⁾	I _F = 2A, T _J = 25°C	V _F	-	1.3	V			
Doverse current @ reted \/-	T _J = 25°C		ı	5	μA			
Reverse current @ rated V _R	(2)	T _J = 125°C	l _R	ı	50	μA		
Junction capacitance		$1MHz, V_R = 4.0V$	С	50	-	pF		
	RS2AH	I _F = 0.5A, I _R = 1.0A I _{rr} = 0.25A	t _{rr}	-	150	ns		
	RS2BH					ns		
	RS2DH					ns		
Reverse recovery time	RS2GH					ns		
	RS2JH			-	250	ns		
	RS2KH			-	500	ns		
	RS2MH					ns		

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION							
ORDERING CODE ⁽¹⁾	PACKAGE	PACKING					
RS2xH	DO-214AA (SMB)	3,000 / Tape & Reel					

Notes:

1. "x" defines voltage from 50V(RS2AH) to 1000V(RS2MH)



CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

Fig.1 Forward Current Derating Curve

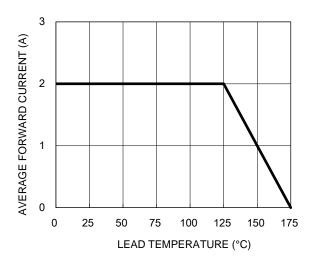


Fig.3 Typical Reverse Characteristics

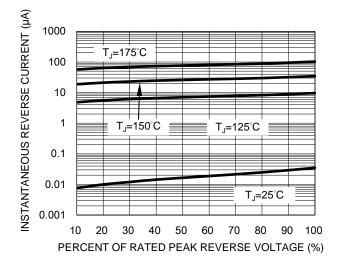


Fig.2 Typical Junction Capacitance

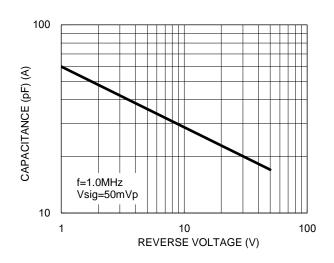


Fig.4 Typical Forward Characteristics

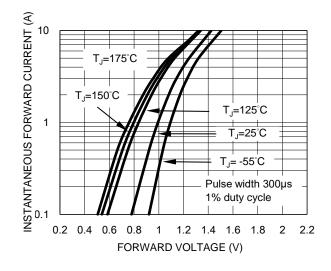
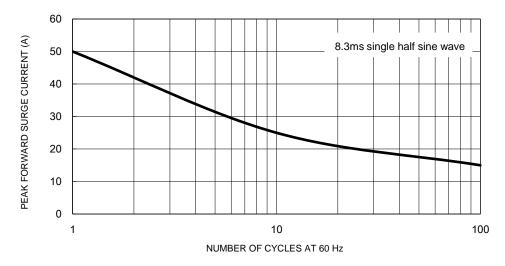


Fig.5 Maximum Non-Repetitive Forward Surge Current



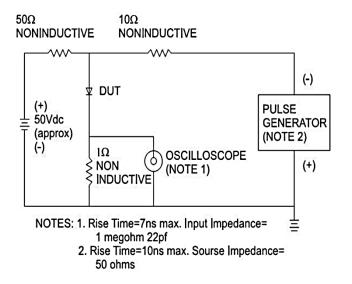


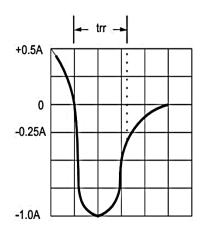


CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.6 Reverse Recovery Time Characteristic and Test Circuit Diagram

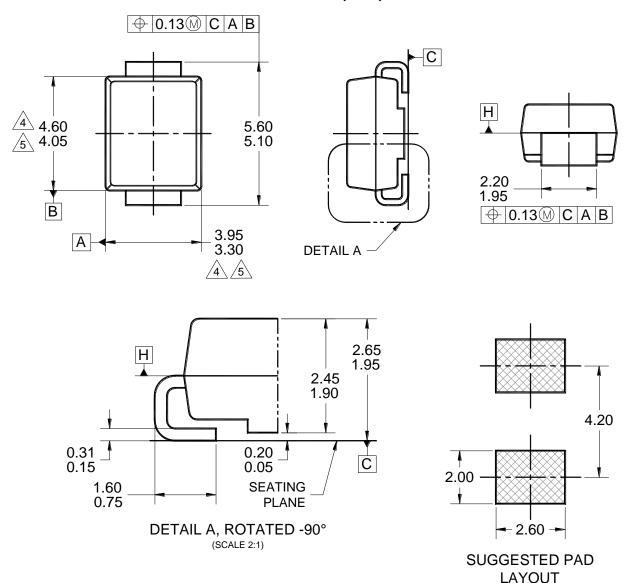


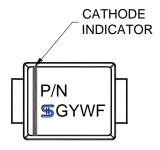




PACKAGE OUTLINE DIMENSIONS

DO-214AA (SMB)





MARKING DIAGRAM

P/N = MARKING CODE

G = GREEN COMPOUND

YW = DATE CODE

F = FACTORY CODE

NOTES: UNLESS OTHERWISE SPECIFIED

- 1. ALL DIMENSIONS ARE IN MILLIMETERS.
- 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- 3. PACKAGE OUTLINE REFERENCE: JEDEC DO-214, VARIATION AA, ISSUE D.
- MOLDED PLASTIC BODY DIMENSIONS DO NOT INCLUDE MOLD FLASH.
- MOLDED PLASTIC BODY LATERAL DIMENSIONS TO BE DETERMINED AT DATUM PLANE H.
- 6. DWG NO. REF: HQ2SD07-DO214SMB-035 REV A.



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